

1. General description

High voltage, high speed NPN planar-passivated power switching transistor in a SOT78 plastic package intended for use in high frequency electronic lighting ballast applications

2. Features and benefits

- Fast switching
- High voltage capability of 700 V
- Low thermal resistance

3. Applications

- Electronic lighting ballasts

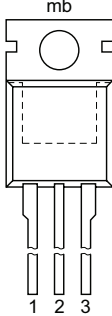
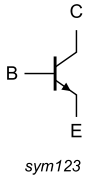
4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Values			Unit
Absolute maximum rating						
V_{CESM}	peak collector-emitter voltage	$V_{BE} = 0 \text{ V}$	700			V
I_C	collector current (DC)	DC; Fig. 1 ; Fig. 2 ; Fig. 4	4			A
P_{tot}	total power dissipation	$T_{mb} \leq 25 \text{ }^\circ\text{C}$; Fig. 3	75			W
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static characteristics						
h_{FE}	DC current gain	$I_C = 1 \text{ A}$; $V_{CE} = 5 \text{ V}$; $T_{mb} = 25 \text{ }^\circ\text{C}$; Fig. 11	12	20	40	
		$I_C = 2 \text{ A}$; $V_{CE} = 5 \text{ V}$; $T_{mb} = 25 \text{ }^\circ\text{C}$; Fig. 11	10	17	28	

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	B	base		
2	C	collector		
3	E	emitter		
mb	C	mounting base; connected to collector		

6. Ordering information

Table 3. Ordering information

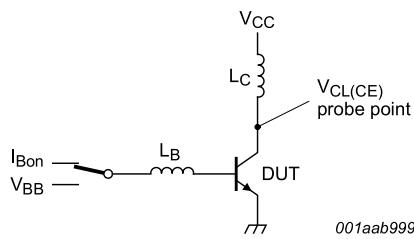
Type number	Package		
	Name	Description	Version
PHE13005	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{CESM}	peak collector-emitter voltage	$V_{BE} = 0\text{ V}$	700	V
V_{CBO}	collector-base voltage	$I_E = 0\text{ A}$	700	V
V_{CEO}	collector-emitter voltage	$I_B = 0\text{ A}$	400	V
I_C	collector current	DC; Fig. 1 ; Fig. 2 ; Fig. 4	4	A
I_{CM}	peak collector current		8	A
I_B	base current	DC	2	A
I_{BM}	peak base current		4	A
P_{tot}	total power dissipation	$T_{mb} \leq 25\text{ °C}$; Fig. 3	75	W
T_{stg}	storage temperature		-65 to 150	°C
T_j	junction temperature		150	°C
V_{EBO}	emitter-base voltage	$I_C = 0\text{ A}$	9	V



$V_{CL(CE)} \leq 1000\text{V}$; $V_{CC} = 150\text{ V}$; $V_{BB} = -5\text{ V}$;
 $L_C = 200\text{ }\mu\text{H}$; $L_B = 1\text{ }\mu\text{H}$

Fig. 1. Test circuit for reverse bias safe operating area

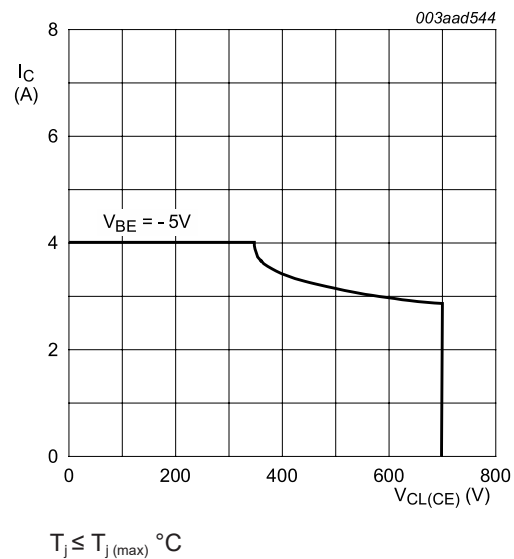


Fig. 2. Reverse bias safe operating area

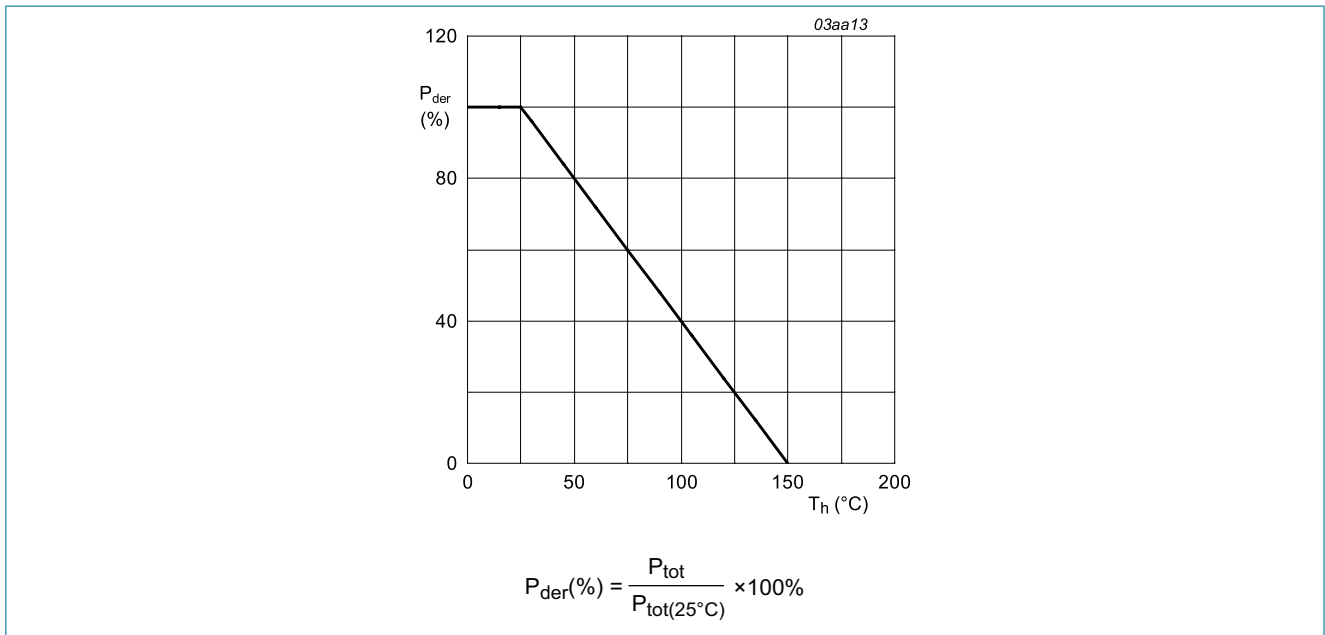


Fig. 3. Normalized total power dissipation as a function of heatsink temperature

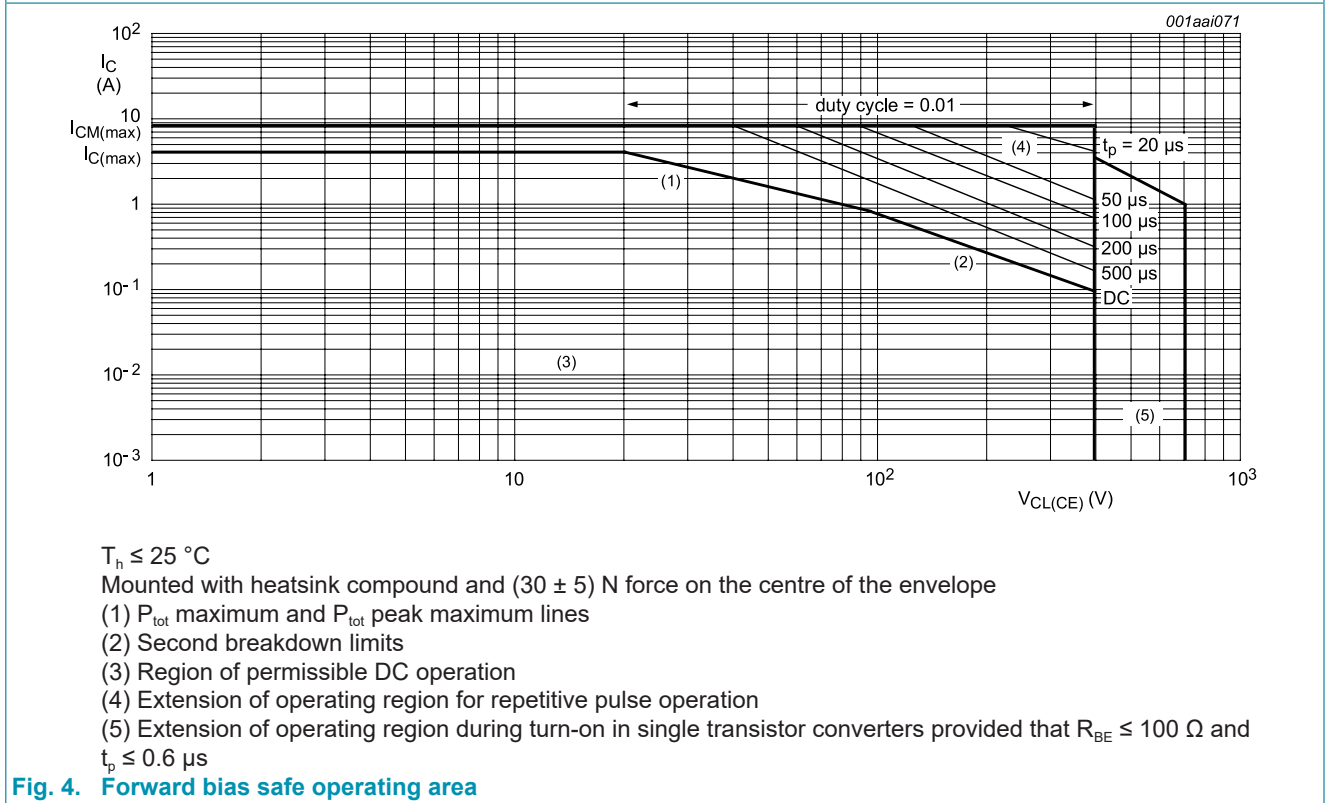


Fig. 4. Forward bias safe operating area

8. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	Fig. 5	-	-	1.67	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	-	60	-	K/W

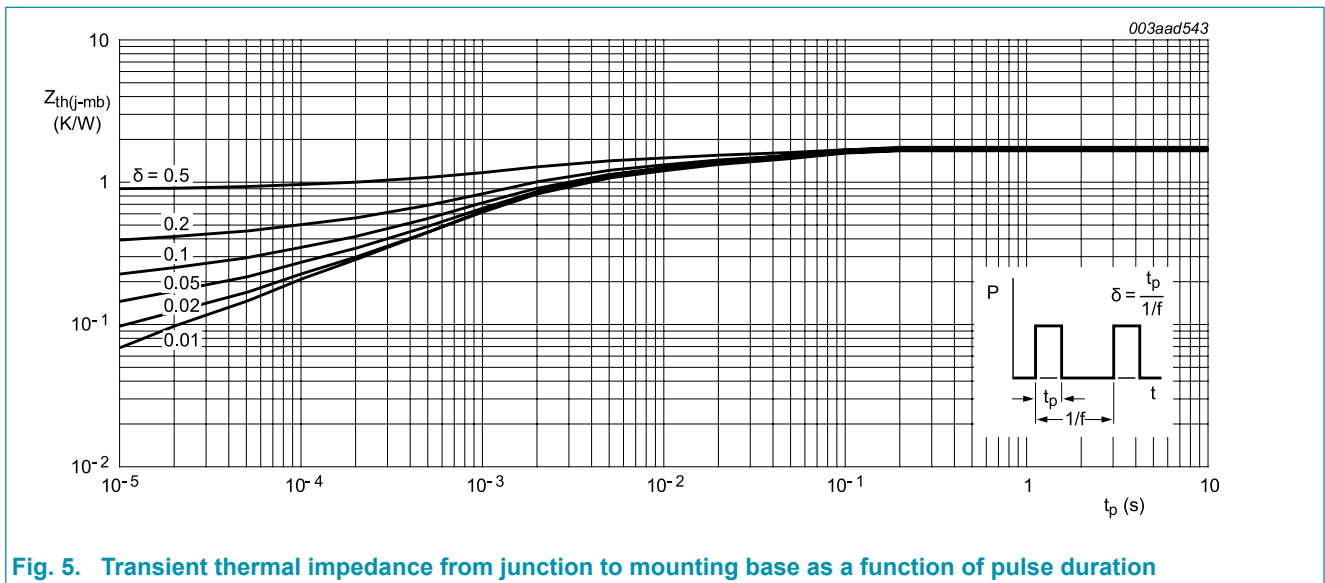


Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse duration

9. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static characteristics						
I_{CES}	collector-emitter cut-off current	$V_{BE} = -1.5 \text{ V}; V_{CE} = 700 \text{ V}; T_{mb} = 25 \text{ }^\circ\text{C}$	-	-	1	mA
		$V_{BE} = -1.5 \text{ V}; V_{CE} = 700 \text{ V}; T_j = 125 \text{ }^\circ\text{C}$	-	-	5	mA
I_{CBO}	collector-base cut-off current	$V_{CB} = 700 \text{ V}; I_E = 0 \text{ A}; T_{mb} = 25 \text{ }^\circ\text{C}$	-	-	1	mA
I_{CEO}	collector-emitter cut-off current	$V_{CEO} = 400 \text{ V}; I_B = 0 \text{ A}; T_{mb} = 25 \text{ }^\circ\text{C}$	-	-	0.1	mA
I_{EBO}	emitter-base cut-off current	$V_{EB} = 9 \text{ V}; I_C = 0 \text{ A}; T_{mb} = 25 \text{ }^\circ\text{C}$	-	-	1	mA
V_{CEOsus}	collector-emitter sustaining voltage	$I_B = 0 \text{ A}; I_C = 10 \text{ mA}; L_C = 25 \text{ mH}; T_{mb} = 25 \text{ }^\circ\text{C};$ Fig. 6 ; Fig. 7	400	-	-	V
V_{CEsat}	collector-emitter saturation voltage	$I_C = 1.0 \text{ A}; I_B = 0.2 \text{ A}; T_{mb} = 25 \text{ }^\circ\text{C};$ Fig. 8 ; Fig. 9	-	0.1	0.5	V
		$I_C = 2.0 \text{ A}; I_B = 0.5 \text{ A}; T_{mb} = 25 \text{ }^\circ\text{C};$ Fig. 8 ; Fig. 9	-	0.2	0.6	V
		$I_C = 4.0 \text{ A}; I_B = 1.0 \text{ A}; T_{mb} = 25 \text{ }^\circ\text{C};$ Fig. 8 ; Fig. 9	-	0.3	1	V
V_{BEsat}	base-emitter saturation voltage	$I_C = 1.0 \text{ A}; I_B = 0.2 \text{ A}; T_{mb} = 25 \text{ }^\circ\text{C};$ Fig. 10	-	0.85	1.2	V
		$I_C = 2.0 \text{ A}; I_B = 0.5 \text{ A}; T_{mb} = 25 \text{ }^\circ\text{C};$ Fig. 10	-	0.92	1.6	V
h_{FE}	DC current gain	$I_C = 1 \text{ A}; V_{CE} = 5 \text{ V}; T_{mb} = 25 \text{ }^\circ\text{C};$ Fig. 11	12	20	40	
		$I_C = 2 \text{ A}; V_{CE} = 5 \text{ V}; T_{mb} = 25 \text{ }^\circ\text{C};$ Fig. 11	10	17	28	
Dynamic characteristics						
t_s	storage time	$I_C = 2 \text{ A}; I_{Bon} = 0.4 \text{ A}; I_{Boff} = -0.4 \text{ A}; R_L = 75 \text{ } \Omega; T_{mb} = 25 \text{ }^\circ\text{C};$ resistive load; Fig. 12 ; Fig. 13	-	2.7	4	μs
		$I_C = 2 \text{ A}; I_{Bon} = 0.4 \text{ A}; V_{BB} = -5 \text{ V}; L_B = 1 \text{ } \mu\text{H}; T_{mb} = 25 \text{ }^\circ\text{C};$ inductive load; Fig. 14 ; Fig. 15	-	1.2	2	μs
		$I_C = 2 \text{ A}; I_{Bon} = 0.4 \text{ A}; V_{BB} = -5 \text{ V}; L_B = 1 \text{ } \mu\text{H}; T_{mb} = 100 \text{ }^\circ\text{C};$ inductive load; Fig. 14 ; Fig. 15	-	1.4	4	μs
t_f	fall time	$I_C = 2 \text{ A}; I_{Bon} = 0.4 \text{ A}; I_{Boff} = -0.4 \text{ A}; R_L = 75 \text{ } \Omega; T_{mb} = 25 \text{ }^\circ\text{C};$ resistive load; Fig. 12 ; Fig. 13	-	0.3	0.9	μs
		$I_C = 2 \text{ A}; I_{Bon} = 0.4 \text{ A}; V_{BB} = -5 \text{ V}; L_B = 1 \text{ } \mu\text{H}; T_{mb} = 25 \text{ }^\circ\text{C};$ inductive load; Fig. 14 ; Fig. 15	-	0.1	0.5	μs
		$I_C = 2 \text{ A}; I_{Bon} = 0.4 \text{ A}; V_{BB} = -5 \text{ V}; L_B = 1 \text{ } \mu\text{H}; T_{mb} = 100 \text{ }^\circ\text{C};$ inductive load; Fig. 14 ; Fig. 15	-	0.16	0.9	μs

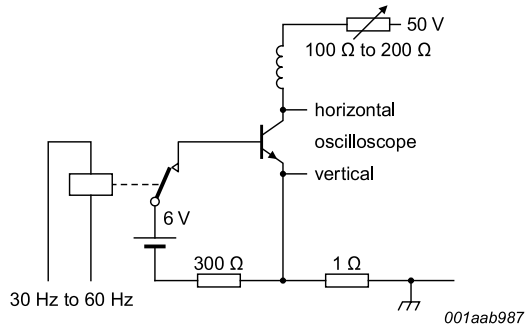


Fig. 6. Test circuit for collector-emitter sustaining voltage

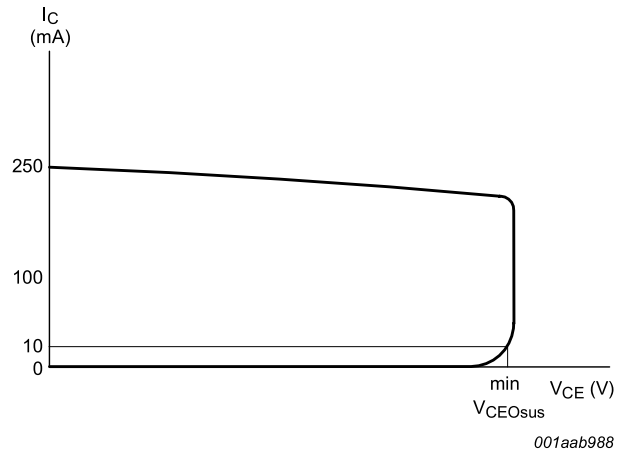


Fig. 7. Oscilloscope display for collector-emitter sustaining voltage test waveform

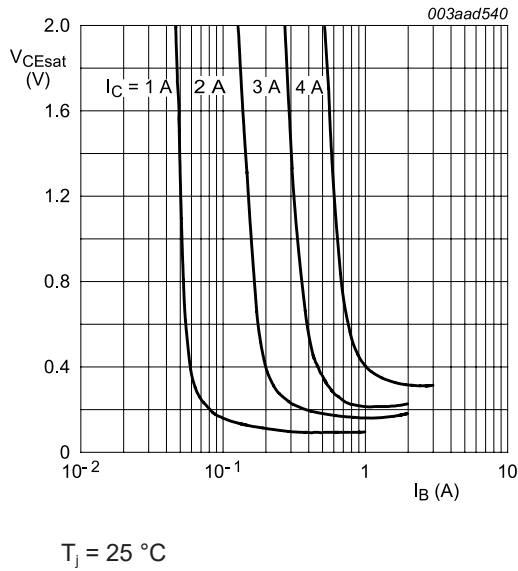


Fig. 8. Collector-emitter saturation voltage; typical values

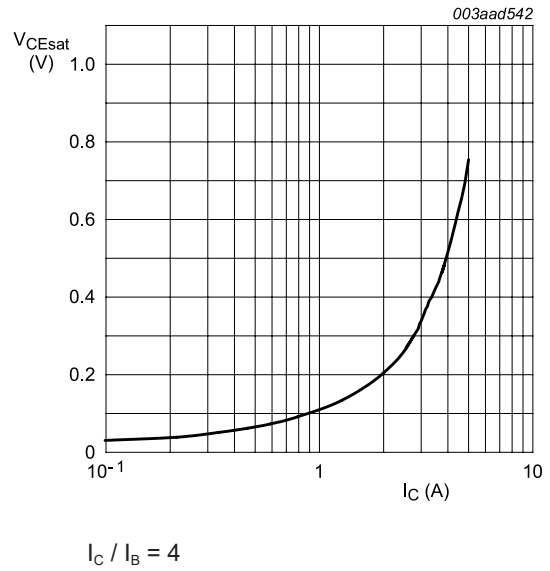
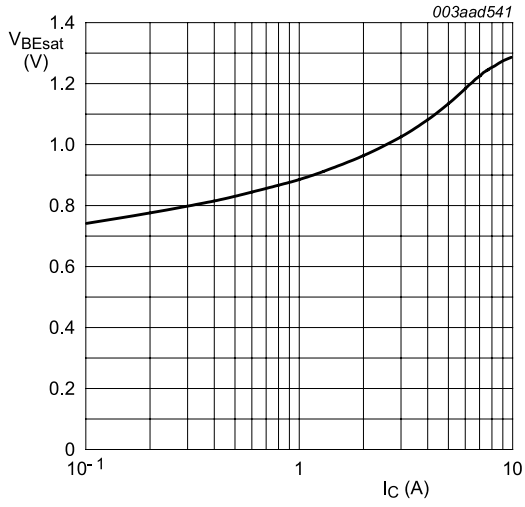
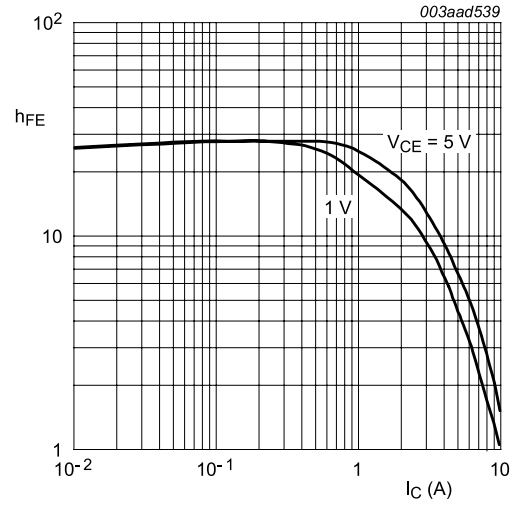


Fig. 9. Collector-emitter saturation voltage as a function of collector current; typical values



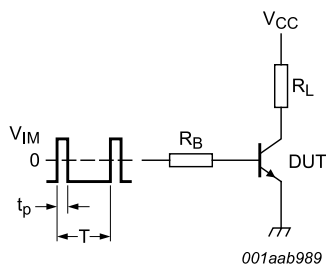
$I_C / I_B = 4$

Fig. 10. Base-emitter saturation voltage; typical values



$T_j = 25\text{ }^\circ\text{C}$

Fig. 11. DC current gain as a function of collector current; typical values



$V_{IM} = -6 \text{ to } +8 \text{ V}$; $V_{CC} = 250 \text{ V}$; $t_p = 20 \text{ }\mu\text{s}$;
 $\delta = t_p / T = 0.01$
 R_B and R_L calculated from I_{Con} and I_{Bon} requirements.

Fig. 12. Test circuit for resistive load switching

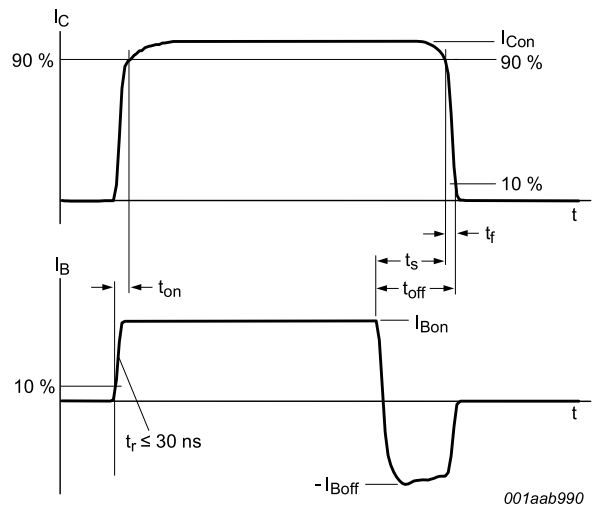
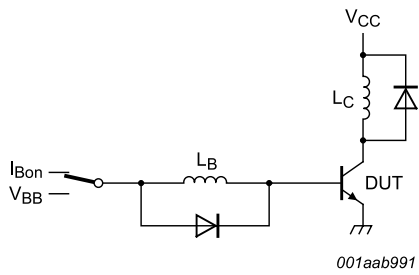


Fig. 13. Switching times waveforms for resistive load



$V_{CC} = 300\text{ V}; V_{BB} = -5\text{ V}; L_C = 200\ \mu\text{H}; L_B = 1\ \mu\text{H}$

Fig. 14. Test circuit for inductive load switching

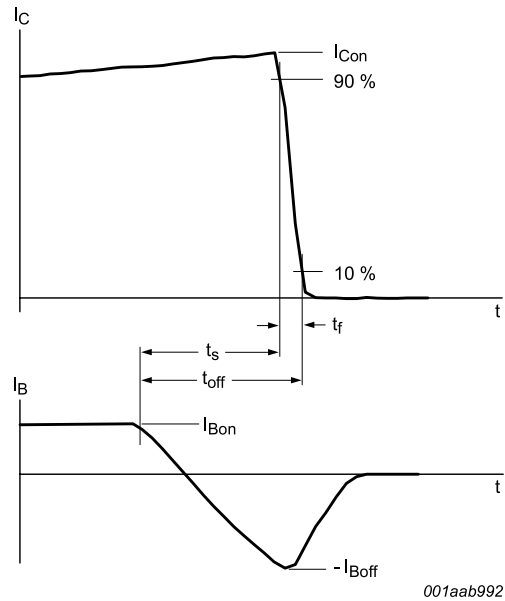


Fig. 15. Switching times waveforms for inductive load

10. Package outline

Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB

SOT78



DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁	b	b ₁ (2)	b ₂ (2)	c	D	D ₁	E	e	L	L ₁ (1)	L ₂ (1) max.	p	q	Q
mm	4.7 4.1	1.40 1.25	0.9 0.6	1.6 1.0	1.3 1.0	0.7 0.4	16.0 15.2	6.6 5.9	10.3 9.7	2.54	15.0 12.8	3.30 2.79	3.0	3.8 3.5	3.0 2.7	2.6 2.2

Notes

- 1. Lead shoulder designs may vary.
- 2. Dimension includes excess dambar.

OUTLINE VERSION	REFERENCES			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA		
SOT78		3-lead TO-220AB	SC-46		08-04-23 08-06-13

11. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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